# ProASIC3/E Proto Kit User's Guide and Tutorial 

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## Introduction

Thank you for purchasing the Actel ProASIC ${ }^{\circledR} 3 / E$ Starter Kit.
This guide provides the information required to easily evaluate the ProASIC3/E devices.

## Document Contents

Chapter 1 - "Contents and System Requirements" describes the contents of the ProASIC3/E Starter Kit. Chapter 2 - "Hardware Components" describes the components of the ProASIC3/E Evaluation Board.
Chapter 3 - "Setup and Self Test" describes how to setup the ProASIC3/E Evaluation Board and how to perform a self test.
Chapter 4 - "Description of Test Design" describes the existing design on the ProASIC3/E Evaluation Board.
Chapter 5 - "LVDS Signal Evaluation" explains test setup and design, reports the measurements performed on the board, and makes recommendations to increase the LVDS signal quality in order to meet the performance criteria.
Chapter 6 - "Actel VHDL ProASIC3/E Design Flow" introduces the design flow for VHDL using the Actel Libero ${ }^{\circledR}$ Integrated Design Environment (IDE) suite.

Chapter 7 - "Quick Start Tutorial" illustrates a VHDL design for a ProASIC3/E starter kit board.
Chapter 8- "Test Procedures for Board Testing" details the test procedure to be carried out at the Actel designated manufacturer's testing facility on the ProASIC3/E Evaluation Board with silkscreen labeling A3PE-A3P-EVAL-BRD-1 REV3.

Appendix A - "PQ208 Package Connections for A3PE600 and A3P250 Devices" provides a table listing the board connections.
Appendix B - "Board Schematics" provides illustrations of the ProASIC3/E Evaluation Board.
Appendix C - "Signal Layers" provides illustrations for the six signal layers of the Evaluation Board.
Appendix D- "Product Support" describes Actel support services.

## Document Assumptions

This user's guide assumes:

- You intend to use Actel Libero IDE software.
- You have installed and are familiar with Actel Libero IDE v6.2 SP1 or later software.
- You are familiar with VHDL.
- You are familiar with PCs and Windows operating systems.


## 1 - Contents and System Requirements

This chapter details the contents of the ProASIC3/E Starter Kit and lists the power supply and software system requirements.

## Starter Kit Contents

The starter kit includes the following:

- ProsASIC3/E Evaluation Board
- Libero IDE Gold
- FlashPro3
- The ProASIC3/E Starter Kit User's Guide and Tutorial
- CD with design examples
- Switching brick power supply (rated from 110 V to 240 V AC) from 50 Hz to 60 Hz input, providing 9 V DC output at up to 2 A, part number DTS090220U-P5P-SZ from CUI INC
For the CD contents, review the ReadMe.doc file at the top level of the CD.


## 2 - Hardware Components

This chapter describes the hardware components of the ProASIC3/E Evaluation Board.

## ProASIC3/E Evaluation Board

Figure 2-1 on page 10 illustrates a top-level view of the ProASIC3/E Evaluation Board.
The ProASIC3/E Evaluation Board consists of the following:

- Wall mount power supply connector, with switch and LED indicator
- Switches to select from among $1.5 \mathrm{~V}, 1.8 \mathrm{~V}, 2.5 \mathrm{~V}$, and $3.3 \mathrm{~V}-\mathrm{I} / \mathrm{O}$ voltages on banks 4 and 5 (southern side)
- 10-pin 0.1 inch pitch programming connector compatible with Altera connections
- 40 MHz oscillator and two independent manual clock options for global reset and pulse
- Eight LEDs (driven by outputs from the device)
- Jumpers (allow disconnection of all external circuitry from the FPGA)
- Two monostable pulse generator switches ("global" and "reset")
- Four switches (provide input to the device)
- Two hex switches to provide four inputs each to the FPGA, and which are set to a user-switchable hexadecimal input value
- Large LCD alphanumeric display to facilitate detailed message outputs from the FPGA application

For further information, refer to the following appendices:
Appendix A - "PQ208 Package Connections for A3PE600 and A3P250 Devices" on page 73.
Appendix B - "Board Schematics" on page 81.

## Detailed Board Description and Usage

The ProASIC3 Starter kit board has various advanced features that are covered in later sections of this chapter. It will be noted that the Advanced Prototyping Starter Kit has a socket on the board into which an end user may place any ProASIC3 device, as all devices in both the ProASIC3 and ProASIC3E families are available in the PQ208 package. The EVAL kit version can be identified as the one that has the FPGA soldered directly to the board.

A block diagram of the ProASIC3 Starter kit board is shown in Figure 2-1 and will facilitate understanding of the more detailed schematics shown in this tutorial in the appendix, "Board Schematics" on page 81.


Figure 2-1 • ProASIC3IE Evaluation Board: Top-Level View
Full schematics are available on the Starter Kit Tutorial CD that is supplied with the Starter Kit. The schematics are also available for download from the Actel website. The electronic versions of the dedicated schematics can naturally be enlarged to a far greater degree than can be shown in the printed version of this manual or even in the electronic version of this manual, hence the interested reader is referred to the dedicated schematics to see the appropriate level of detail.

## PLL Parts/Usage on ProASIC3

## Instructions for PLL Activation on ProASIC3 Starter Kit Board

In order to use the PLLs on the ProASIC3 starter kit board, power must be applied to their respective analog supply rails. For the west side PLL, known as PLF, the VCCPLF line must be connected to VCC, which is held at 1.5 V . The same is true for VCCPLC of the PLL on the east side, known as PLC. In addition, the VCOMPLF and VCOMPLC lines must be connected to ground. We do not connect these voltages by default on the board for three reasons:
3. The PLC analog voltage rails are not available on A3P devices, only on A3PE in the PQ208 package. Only the west side PLL, namely PLF, is available on A3P devices in PQ208. In A3P devices, the pins are used as general I/Os. The same board is used for A3PE and A3P devices.
4. We want to demonstrate the lowest possible power consumption for the part. Perpetually powering the PLL lines would not achieve that.
5. It is easy to connect the appropriate pins together when desired. That is why we make the pins available on the headers.
A variety of valid connections are possible. Two examples are as follows:

1. For PLF, connect pin 27 (VCCPLF) to pin 36 (VCC), and pin 25 (VCOMPLF) to pin 17 (GND).
2. For PLC, (A3PE only) connect pin 131 (VCCPLC) to pin 142 (VCC), and pin 133 (VCOMPLC) to pin 141 (GND).
To facilitate end users, we will be supplying jumper wires with selected production versions of the kit to allow end users to quickly connect and disconnect these voltage supply rails. If a user has lost the jumper wires or has a production kit without jumper wires, it is a simple matter of soldering short insulated connecting wire to the appropriate header pins on the J14A and J14C headers.

## Power Supplies

A 9 V power supply is provided with the kit (Figure 2-2). There are many power supply components in the starter kit board to illustrate the many ways that differing voltage banks may be supported with ProASIC3 and ProASIC3E technology. These voltage banks are not all required for general use of ProASIC3 silicon. They are provided purely for illustrative purposes.


Figure 2-2• Power Supply Block Diagram

## Microsemi.

## Hardware Components

To use the ProASIC3/E Evaluation board with a wall mount power supply, use the switching brick power supply that is provided with the kit.
The external +9 V positive center power supply provided to the board via connector J16 goes to a voltage regulator chip U11 on the evaluation board. As soon as the external voltage is connected to the board, the red power applied LED (the only red LED on the board) D19 illuminates to indicate that an external supply has been connected to the board. As soon as switch SW11 is moved to the ON position (to the right, as labeled on the board "OFF/ON"), the disabling ground signal is removed from pin 7 of U11 and the regulator begins to provide power at its output.
The U11 switching voltage regulator provides a dedicated 3.3 V supply at its output. The board's 3.3 V supply is used for feeding separate regulators that deliver 1.5 V (via U15), 1.8 V (via U12) and 2.5 V (via U15). The 1.5 V is required for the core voltage of the ProASIC3 family, and the 2.5 V is required for demonstrating LVDS extended I/O bank capability.
The presence of these voltages is indicated by four green LEDs (D13, D9, D10, and D11 respectively) illuminating at the top right of the board. Each LED is labeled with the voltage it represents and its component identifier. All four voltages are selectable on the I/O banks 4 and 5 (the two southernmost banks on a ProASIC3E device).
Note: Only ProASIC3E devices have 8 I/O banks. ProASIC3 devices have four I/O banks-one per side of the PQ208 package.]
The 3.3 V supply is also used for optionally providing the VPUMP programming voltage. This VPUMP voltage may be provided to the chip during programming by applying a FlashPro3 programmer to the J 1 interface and selecting VPUMP from the FlashPro v3.3 (or later) programming software. VPUMP voltage may also be provided directly to the chip from the board.
Simply leave the JP48 jumper in place to apply the 3.3 V supply to the VPUMP pin (106 of the PQ208 packaged FPGA). Note that if both FlashPro3 and the board are selected to provide VPUMP, then it is the connection on the board that will override, as FlashPro3 will detect that a voltage is available, issue an information message in the programming software, and then move the VPUMP output pin to a tristate value, allowing the board to provide all the power.
The board must be powered-up during programming because the chip needs its core voltages to be provided and VJTAG must be detected by the FlashPro3 programmer in order for it to set its JTAG signal voltages to the right level.
The LCD has its own dedicated 5 V power supply, all components of which (including the regulator U20) are marked on the circuit board in a boxed area so that you may know which components on the PCB are associated with which tasks. An LED (D17) representing the 5 V supply availability is positioned at the top left of the board.
The external +9 V power supply is rated at 2 A maximum. On the first of the full-page dedicated schematics shown in the appendix "Board Schematics" on page 81, it will be noted that the 3.3 V supply is rated at 5 A maximum. The derived power supplies of $1.5 \mathrm{~V}, 1.8 \mathrm{~V}$, and 2.5 V are rated at 2 A max each, and the LCD 5 V power supply is rated at 500 mA , as shown in Figure $\mathrm{B}-11$ on page 92 . Clearly, not all these derived supplies can be working at their respective maximum current outputs simultaneously. The maximum ratings are for the individual regulator ICs and cannot be numerically added together.
Both the U11 (LM2678S-3.3) and U20 (LM2674M-5.0) components are rated for an input voltage range of +8 V to +40 V , so a wide range of power supplies may be used with the board with no concern about over-voltage conditions occurring from inadvertent accidental usage of the wrong power supply. However, the user should take care to ensure that the voltage provided is positive at the center pin of the J16 connector and grounded on the outside. Greater heating of the regulator chips will be observed with higher voltages. It is therefore recommended that only the included power supply or an equivalent substitute be used with the evaluation kit. The included power supply has been rated for this board, including Actel daughter cards that may be attached to the board.

## Daughter Card Power Supply Connections

Limited power to a daughter card may be supplied by the board. The connector for the daughter card is shown in Figure B-7 on page 88 and is the J 12 header. All the FPGA voltages of $1.5 \mathrm{~V}, 1.8 \mathrm{~V}, 2.5 \mathrm{~V}$, and 3.3 V are provided to the daughter card via a 12 -pin 0.1 inch pitch connector. The voltages are arranged with a no-connection pin interspersing the voltage pins. This prevents accidental use of a jumper to short a supply rail to ground, which could connect differing supply rails together. The purpose is not to protect the power supply regulators, as these will go high-impedance when an over-voltage condition is detected. It is to protect the FGPA from unintentional application of a higher voltage to the 1.5 V core. Three of the twelve pins are ground pins, which will provide more than sufficient current return capability for future Actel daughter cards that will work with this board

## Power Supplies and Chaining Boards Together

There is a special note on "VPUMP Connections When Chaining Boards Together" on page 14. Instructions are detailed here but the novice reader is advised to return to this section after reading the section on standard JTAG programming connections via FlashPro3

When joining multiple ProASIC3 starter kit boards together via the chain programming connection, bear in mind that the J 2 connector is used to connect to the J 1 connector of the next board in the chain by attaching a standard 0.100 -inch pitch 10 -pin programming cable. The length of the cable does need to be kept as short as possible, because multiple boards connected to form a JTAG chain of ProASIC3/E devices will provide much greater noise pick-up and may degrade the TCK clock for devices remote from the FlashPro3 programmer. Set VJTAG at an absolute minimum of 1.8 V to help with signal integrity when chaining boards together. Higher voltages will give better noise and impedance mismatch immunity

Disconnect the jumper at JP10 on all boards. This jumper can be used to provide VJTAG to a downstream board or to some element in the design that you wish to supply with the VJTAG voltage used by the ProASIC3/E component. The shunt that is normally in this location can be safely stored across pins 11 and 12, or 9 and 10 of the J12 daughter card power supply connector. For particularly long chains, the value of TCK used during programming should be reduced.

During its development, various revisions of the ProASIC3 Starter Kit board have been produced. This documentation contains additional text that documents some of these earlier versions, as well as the newest Rev3 version of the board. Schematics for Rev3 and Rev2 boards are the same when viewed as PDF files, but there is a short in the board layers on the Rev2 that has been corrected for Rev3. The rare Rev1 prototype boards had different schematics and are not discussed in this document.

## Procedure for Rev3 Boards

## To determine if the board is a Rev3 board:

A Rev3 Board is recognized by examining the front of the board and looking for the part number just beneath the large Actel corporate logo on the board top silk-screen. The part number will be A3PE-A3P-EVAL-BRD1 followed by REV3.

## To chain Rev3 boards together:

All boards from the board nearest the FlashPro3 programmer should have the shunt that is placed by default on pins 3 and 4 of the $J 5$ header moved to connect pins 1 and 2. On the board and schematic this is labeled quite clearly as CHAIN (pins 1 and 2) and LAST DEVICE (DEFAULT) (pins 3 and 4). Only the very last board in the chain should have the shunt remaining across pins 3 and 4 of the 35 connector.

Note that if there is only one board in the chain then it, by definition, is the last board and should have the shunt at J5 connecting pins 3 and 4. This is why this position is labeled as the DEFAULT position for a typical customer with a single starter kit board.

## Procedure for Rev2 Boards, With and Without Rework

## To determine if the board is a Rev2 board:

A Rev2 board is indicated by a red power LED in the upper right corner of the board and a part number underneath the Actel corporate logo on the board top silk-screen. The part number will be "A3PE-A3P-EVAL-BRD1". No additional text will follow the board number. If the board has been reworked to force it to become equivalent to a Rev3 board, it will contain a green wire on the top side of the board. If it does not contain green wire, it is an original Rev2.

## To chain Rev2 boards together:

If reworked, treat it as Rev3 in the previous section. If not reworked, then chaining of the boards cannot be done. The shunt on $\mathrm{J5}$ must be removed for any programming to take place.

## Procedure for Rev1 Boards

## To determine if the board is a Rev1 board:

A Rev1 Board is indicated by no red power LED in the upper right corner of the board. The part number on the board top silk-screen is A3PE-EVAL-BRD600.
Note: Rev1 boards should not be used with this tutorial guide or with design files included with this Starter Kit as the schematics are incompatible with current commercial boards.

## VPUMP Connections When Chaining Boards Together

When these boards are connected via a connection from J 2 of one board to J 1 of another board, $\mathrm{V}_{\text {PUMP }}$ will be connected from one board to another. When powering on one board with a connector in place, notice that the $1.5 \mathrm{~V}, 1.8 \mathrm{~V}, 2.5 \mathrm{~V}$, and 3.3 V LEDs will light on the board to which no power has been applied. The FPGA on that board, if it is programmed, will start operating. This is clearly an inappropriate situation for a large chain of boards. This is caused by having the JP48 connector for supplying $\mathrm{V}_{\text {PUMP }}$ from the board connected on other boards in the chain, as VPUMP is itself connected to the 3.3 V supply output that is used to generate the other FPGA voltages on a board. To prevent VPUMP from being used as the source of a 3.3 V supply, you should remove the shunt that is in place on the JP48 connector to force JP48 to be open-circuit. To prevent loss of the shunt, it may be safely stored on the J12 header for the daughter card power supply as it is impossible to cause a short by joining any adjacent pins.

## Programming the A3PE-A3P-EVAL-BRD1 with a FlashPro3

The base board used for all ProASIC3/E starter kits is the A3PE-A3P-EVAL-BRD1.
In an A3PE-PROTO-KIT, the particular board is an A3PE-EVAL-BRD600-SKT. In an A3PE-EVAL-KIT, the board is an A3PE-EVAL-BRD600-SA. The only difference between these two is that the -SKT indicates that the board is fitted with an A3PE600-PQ208 part, which is mounted in a PQ208 screw-down socket.
In an A3P-PROTO-KIT, the particular board is an A3P-EVAL-BRD250-SKT. In an A3P-EVAL-KIT, the board is an A3P-EVAL-BRD250-SA. The only difference between these two is that the -SKT indicates that the board is fitted with an A3P250-PQ208 part, which is mounted in a PQ208 screw-down socket.
In a kit with a socket on the board, a reasonable number of insertions may be made if the user exercises great care in inserting components into the socket. Note that screw-down sockets are not clam shell sockets, and do have a lifetime of about 20 insertions, although far greater may be achieved with careful placement and use of a torque-limiting screwdriver. Placement of the FPGA in the socket is critical, to ensure all pins are correctly connected.

## Connecting the FlashPro3 Programmer to the Board

Connect the FlashPro3 programmer to your computer via the USB cable. Follow the instructions in the User's Guide with FlashPro v3.3 (or later) software for installing the software and connecting to FlashPro3. The amber (yellow) power LED on the FlashPro3 should be illuminated at this stage. If it is not, recheck the procedure in the FlashPro User's Guide until you obtain a steady amber (yellow) power LED illumination.
Make sure the board power switch SW11 is in the OFF position and only the red board external power LED is illuminated on the board.

Connect the FlashPro3 programmer to the board via the 10-pin programming cable supplied with the FlashPro3 programmer hardware. The connector to use on the board is labeled FP3 and is the lower J1 shrouded and keyed header. The pin 1 location on the cable indicated by the red ribbon running along the side of the cable will be on the left side as it enters into the board. After connecting the FlashPro3 programmer, select Analyze Chain from the File menu in the FlashPro software. If all is well, the appropriate device ID for the ProASIC3 or ProASIC3E part will show in the software display on the PC. If you suspect a JTAG communication issue, try changing the VJTAG voltage. For overcoming noise, higher values usually work better, but all values should work with the supplied programming cable (6 inches in length) with connection to just one board.

## Programming or Re-Programming the Example Design

On the Starter Kit CD you will find a Designer directory containing a STAPL file for programming the target design. Select the TOP_A3PE.STP file (for A3PE600 parts) or the TOP_A3P.STP file (for A3P250 parts) from the CD and use that as the STAPL file in the FlashPro software. Selecting the PROGRAM action will erase, program, and verify the part (note that Verify is disabled with A3PE600 RevC silicon). With RevC silicon the overall programming time for an A3PE600-PQ208 will be 2 minutes, 4 seconds. With RevD silicon, the time will be approximately 30 seconds.

## Jumpers for Isolating Switches and LEDs from FPGA

Many jumpers are provided on the board to allow the user to disconnect various switch combinations or LEDs from the FPGA I/O banks. All such jumpers are shown in the schematic in Figure B-1 and are labeled on the top-layer silkscreen as $\mathrm{JP}^{*}$ where * is a number. All jumpers are also labeled with the FPGA I/O pin number to which they are connected; e.g., JP48 for the 3.3 V connection of $\mathrm{V}_{\text {PUMP }}$ to the FPGA is labeled with "106," which indicates that it is connected to pin 106. Similarly, SW4 has a jumper above it called JP14, which is labeled with "64," indicating that SW4 is connected through to pin 64 of the FPGA when this jumper is in place.
Disconnecting the jumpers JP11, JP12, JP13, and JP14 causes the momentary push button switches (SW1, SW2, SW3, and SW4 respectively) to be disconnected from the FPGA so that the I/O pins 68, 67, 66 , and 64 may be used for other purposes. Disconnecting the eight jumpers, JP1 through JP8, causes the eight Light Emitting Diodes (D1 through D8) to be disconnected from the FPGA I/O pins 63, 61, 60, $59,58,57,56$, and 55 , respectively.
The momentary push button switches (SW5 and SW6, for applying a reset pulse and a global pulse) are connected via jumpers JP15 and JP16 to I/Os 159 and 113 respectively. Again, all labeling is clearly shown on the silk screen.
The hex switches U13 and U14 each are connected to four I/Os on the FPGA. There are four separate jumpers for each of these hex switches, located on the bottom right of the board. They are labeled with Bit0, Bit1, Bit2, and Bit3 on the silk screen, as well as being labeled with the I/O pin on the FPGA to which each is connected. This allows you to individually control the desired effect of a switch and, by connecting directly to the FPGA side of a disconnected jumper, hold a particular pin at a chosen logic level while continuing to use the hex switch to affect other pins. This flexibility is useful for experimentation with designs of your own choosing and connecting other external equipment to the board for development purposes.
The internal and external oscillator selection via JP24 is worth a mention. JP24 is a three-pin header onto which a normal two-hole shunt is fitted. Normally the shunt is connected across pins 3 and 2 of JP24. In this position the on-board oscillator, U1, provides the internal clock to the middle pin of the jumper which in turn is connected to pin 26 of the FPGA. By moving the shunt down to connect pins 2 and 1 of JP24, the external clock at pin 1 is connected to the FPGA instead. The external clock is connected via the SMA connector J19 at the bottom left of the board.
The LCD display also has associated jumpers for the data: JP41, JP42, JP43, and JP44, located on the top left side of the board. These are connected to I/O pins 197, 198, 194, and 193 respectively. The LCD control signals "Enable," "R/W," and "RS" are provided from I/O pins 190, 192, and 191 via jumpers JP47, JP45, and JP46 respectively.

## Test Points

All test points on the board are fitted with small test loops. These test points are labeled on the silkscreen as TP1, TP2, etc. All such test points are also labeled on the silk screen with the voltage expected to be observed at that test point. Voltages will be one of $3.3 \mathrm{~V}, 2.5 \mathrm{~V}, 1.8 \mathrm{~V}, 1.5 \mathrm{~V}$ or GND. When measuring the voltage at a test point with a DVM (digital voltage multimeter), the ground lead should be connected to a test point labeled GND and the voltage lead should be connected to the voltage to be tested. All voltage labels on the board are relative to a 0 V ground reference or GND.

## Prototyping Area

The prototyping area to the right of the board has the bottom two rows of pins connected to ground, labeled as GND on the silk screen and enclosed in a box, giving 16 holes connected to 0 V . The top two rows of pins are connected to various power supply rails internally in the board. They are grouped into squares of four pins from left to right as follows: $3.3 \mathrm{~V}, 2.5 \mathrm{~V}, 1.8 \mathrm{~V}$, and 1.5 V , giving four holes for each voltage level. All other holes in the prototyping area are unconnected and may be used to hold various discrete components as necessary for experimentation.
Next to the prototyping area is U2, which is a space for an optional oscillator. This space may be used for fitting a second oscillator to the board, similar to the one used at U1, so as to provide two different frequency clocks to the FPGA.
On the reverse side of the board, there is an area labeled U5, which is a TQ100 pattern with some surrounding pads. This area may be used to solder a TQ100 part, and then connect that part by adding discrete wires to the pads and connecting it to desired pins on the board. The main purpose of this is to allow a previously programmed TQ100 packaged device to be used to provide a more interesting system application.

## Layering on Board

The complete board design and manufacturing files are included on the Starter Kit CD. The board file is in Allegro format, which will allow an end user to create the appropriate Gerbers and other board views as needed. Pictures of the layers of the board are also attached in the "Signal Layers" section on page 93 of this User's Guide. For your convenience, high-resolution PDFs of these layers are also provided on the Starter Kit CD.
The board is fabricated with 6 layers of copper. The layers are arranged as follows from the top of the board down to the bottom:

Layer 1 - Top signal layer
Layer 2 - Ground Plane
Layer 3 - Signal layer 3, used for LVDS receive and other signals
Layer 4 - Signal layer 4, used for LVDS transmit and other signals
Layer 5 - Power Plane
Layer 6 - Bottom signal layer
Note: It will be noted for signal integrity that the two LVDS layers are sandwiched between ground and power planes to isolate them as best as possible from external influences.
Refer to the diagrams in "Signal Layers" on page 93.

## Clock Circuits

The ProASIC3/E Evaluation Board has two clock circuits: a 40 MHz oscillator and a manual clock.

## 40 MHz Oscillator

The 40 MHz oscillator on the board is a 10 ppm stability crystal module which will give good LVDS performance. Should better stability be required, an external oscillator may be provided via the SMA connector. Typically a TCXO will give 1 ppm stability and an OCXO will give 0.1 ppm stability. Both the default on-board oscillator and the SMA are connected to the CLK F input of the West bank of the FPGA. Position is also provided on the board for mounting a second crystal oscillator module connected to the CLK C input of the FPGA on the East bank.

## LED Device Connections

Eight LEDs are connected to the device via jumpers. If the jumpers are in place, the device I/O can drive the LEDs. The LEDs change based on the following output:

- A ' 1 ' on the output of the device lights the LED.
- A ' 0 ' on the output of the device switches off the LED.
- An unprogrammed or tristated output may show a faintly lit LED.

Note: If the I/O voltage of Bank 5 (on A3PE, set by SW8) or Bank 2 (A3P, set by SW8 and SW7 being at the same level) is not at least 2.5 V , the LEDs will not illuminate. A setting of 1.8 V on the voltage bank will cause extremely faint illumination.
Table 2-1 lists the LED/device connections.
To use the device I/O for other purposes, remove the jumpers.
Table 2-1 • LED Device Connections

| LED | Device Connection |
| :--- | :---: |
| D1 | U8 Pin 63 |
| D2 | U8 Pin 61 |
| D3 | U8 Pin 60 |
| D4 | U8 Pin 59 |
| D5 | U8 Pin 58 |
| D6 | U8 Pin 57 |
| D7 | U8 Pin 56 |
| D8 | U8 Pin 55 |

## Switches Device Connections

Four switches are connected to the device via jumpers. If the jumpers are in place, the device I/O can be driven by the switches listed in Table 2-2.

- Pressing a switch drives a ' 1 ' into the device. The ' 1 ' continues to drive while the switch is in place.
- Releasing a switch drives a zero into the device.

Table 2-2 lists the switch/device connections.
To use the device I/O for other purposes, remove the jumpers.
Table 2-2 • Switch Device Connections

| Switch | Device Connections |
| :--- | :---: |
| SW1 | U8 Pin 68 |
| SW2 | U8 Pin 67 |
| SW3 | U8 Pin 66 |
| SW4 | U8 Pin64 |

## FPGA - LCD Interface

An $8 \times 1$ LCD module is provided on the ProASIC3 Evaluation board for demonstrating the board's functionality. Table 2-3 provides detailed information about the LCD module.

Table 2-3 • LCD Module Details

| Part Number | MDLS-81809-SS-LV-G-LED-04-G |
| :--- | :--- |
| Manufacturer Name | VARIRONIX |
| Display Type | STN - Super-Twisted Nematic |
| Display Mode | Transflective |
| Display Format | $8 \times 1$ |
| Character Format | $5 \times 8$ Dots |
| Character Size | $6.45 \mathrm{~mm} \times 10.75 \mathrm{~mm}$ |
| Backlight | LED Backlighting - Green |
| Viewing Area | $61 \mathrm{~mm} \times 15.8 \mathrm{~mm}$ |
| Operating Temperature | $-5^{\circ} \mathrm{C}$ to $+50^{\circ} \mathrm{C}$ |
| Voltage-Supply | 5 V |

## Description

The LCD module MDLS-81809-SS-LV-G-LED-04-G can be operated in either 4-bit data mode or 8-bit data mode. In this PA3 evaluation board, the above LCD module is being operated in 4-bit data mode to minimize the number of FPGA lines committed to the interface. The 4-bit data lines (DB4, DB5, DB6, and DB7) and the required control signals for this LCD module, specifically RS (Register Select), R/~W (Read/~Write), and E (Enable) lines, are driven from BANKO I/O lines of FPGA. These BANKO I/O lines of FPGA are configured as LVTTL outputs for driving the LCD.
Both VCCI and VMV power points of Bank0 are from a fixed 3.3 volts source, thereby enabling BANKO to function in LVTTL mode.
The interconnection details between the FPGA and the LCD module are listed in Table 2-4.

## Table 2-4•FPGA - LCD Interconnections

| FPGA Pin No. | LCD Pin No. | LCD Pin Name |
| :--- | :---: | :--- |
| 197 | 14 | DB7 |
| 198 | 13 | DB6 |
| 194 | 12 | DB5 |
| 193 | 11 | DB4 |
| 192 | 5 | R / ~W (Read / ~Write) |
| 191 | 4 | RS (Register Select) |
| 190 | 6 | E (Enable) |

When the user of the evaluation board is in need of these BANKO I/O lines of FPGA for his application, the shorting links inserted on the 2-pin headers JP41, JP42, JP43, JP44, JP45, JP46, and JP47 are to be removed. Refer to Figure B-6 on page 87. These BANKO I/O lines of FPGA are also available on J14, J15, J16, and J17 for user evaluation.

## Caution

Both the removal and insertion of shorting links on the JP41, JP42, JP43, JP44, JP45, JP46, and JP47 must be carried out only when the entire PA3 evaluation board is in powered OFF condition.
Note: Using an R40 potentiometer, the contrast of letters displayed on the LCD can be varied.

## LCD Power Supply Circuit

Power to the LCD module power supply is sourced from the LM2674M-5.0 switching regulator, which can provide up to 500 mA .

## Description

The MDLS-81809-SS-LV-G-LED-04-G LCD module requires a 5 V power supply. This is derived from VIN (DC power jack J18). From VIN, which is at most 24 volts DC, the 5 volts required for the LCD module is derived using the LM2674M-5.0 high efficiency 500 mA switching regulator U20.
The ON/OFF control required for the U20 is controlled by SW11.
Note: SW11 also controls U11 and hence all the board regulator power supplies.
The presence of the LCD power supply ( 5 V ) from U20 is indicated by the LED D17. The glowing of D17 indicates the presence of a 5 V power supply.
When the user of the PA3 evaluation board does not need the LCD at all, the shorting links on JP41, JP42, JP43, JP44, JP45, JP46, and JP47 headers are to be removed. Follow the procedure listed in the "Caution" section on page 19.
Refer to Figure B-11 on page 92 for the LCD power supply circuit details.

## LVDS Channels

Four LVDS channels with up to a maximum signaling rate of 350 MHz are supported on the evaluation board. These LVDS signals are brought out to a pair of RJ-45 (CAT-5E) sockets (J40 and J41). Refer to the PA3 Evaluation board PCB layout, Figure 2-1 on page 10, for the position of these connectors.
The LVDS signals are driven using 8 differential pairs (consisting of 16 I/O pins) from the west side (Bank6 and Bank7) of the FPGA device A3PE600-PQ208. These 16 signals are terminated on the J40 and J41 connectors. The FPGA Pins used for LVDS signaling are listed in Table 2-4 on page 18.
The LVDS signals are terminated on J 40 and J 41 connectors so that a standard patch cable can be used for doing loop-back testing. Refer to Figure 2-1 on page 10 of the PA3 evaluation board schematics for schematic representation of connector signal details.
The 4 differential pairs (consisting of $8 \mathrm{I} / \mathrm{O}$ pins) are terminated as shown in Table 2-5 on page 20 using the color convention on the first RJ45 connector (which we'll call "CAT 5E Primary" for the purposes of differentiating it).

Table 2-5 • Color Convention on CAT 5E Primary

| White/Orange | p1 | TX1+ |
| :--- | :---: | :---: |
| Orange | p2 | TX1- |
| White/Green | p3 | RX1+ |
| Blue | p4 | TX2- |
| White/Blue | p5 | TX2+ |
| Green | p6 | RX1- |
| White/Brown | p7 | RX2+ |
| Brown | p8 | RX2- |

Notes:

1. $T X n+$ refers to positive signal of the transmit side of balanced signal Transmission.
2. $T X n$ - refers to negative signal of the transmit side of balanced signal Transmission.
3. $R X n+$ refers to positive signal of the receive side of balanced signal Transmission.
4. $R X n-r e f e r s ~ t o ~ n e g a t i v e ~ s i g n a l ~ o f ~ t h e ~ r e c e i v e ~ s i d e ~ o f ~ b a l a n c e d ~ s i g n a l ~ T r a n s m i s s i o n . ~$

The 4 differential pairs (consisting of 8 I/O pins) are terminated as shown in Table 2-6 using the following color convention on the second LVDS connector (which we'll call "CAT 5E SECONDARY" for the purposes of differentiating it).
Table 2-6 • Color Convention on CAT 5E Secondary

| White/Orange | p1 | RX3+ |
| :--- | :---: | :---: |
| Orange | p 2 | RX3- |
| White/Green | p 3 | TX3+ |
| Blue | p 4 | RX4- |
| White/Blue | p 5 | RX4+ |
| Green | p 6 | TX3- |
| White/Brown | p 7 | TX4+ |
| Brown | p8 | TX4- |

Note: The colors refer to the colors that will appear on the CAT 5E cable. The pin numbers correspond to the pin numbers of an RJ-45 connector. Note that the CAT-5E PRIMARY connections are labeled for the purposes of what is regarded as standard connections for CAT-5E on Ethernet-type connectors. The connections on the CAT-5E SECONDARY are reversed so as to allow a standard patch cable to check loopback on these LVDS signals.
A 1-foot CAT5 standard patch cable supplied with the PA3 evaluation kit can be used for LVDS signals loopback.

Also note that the VCCI and VMV voltages of Bank6 and Bank7 (west side) are connected to a fixed 2.5 volts, which is required in ProASIC3 (LVDS only available in A3P250 and larger) and ProASIC3E (LVDS available in all devices) for LVDS signaling.

Table 2-7 • FPGA - LVDS I/O Pin Details

| FPGA Pin No. | FPGA I/O Pin Name $^{\mathbf{1}}$ | Signal Name | CAT5E Connector Pin No. |
| :--- | :---: | :---: | :---: |
| 7 | GAC2/IO132PDB7V1 | TX1+ | CAT 5E - PRI -1 |
| 8 | IO132NDB7V1 | TX1- | CAT 5E - PRI -2 |
| 9 | IO130PDB7V1 | TX2+ | CAT 5E - PRI -5 |
| 10 | IO130NDB7V1 | TX2- | CAT 5E - PRI - 4 |
| 11 | IO127PDB7V1 | RX1+ | CAT 5E - PRI -3 |
| 12 | IO127NDB7V1 | RX1- | CAT 5E - PRI - 6 |
| 13 | IO126PDB7V0 | RX2+ | CAT 5E - PRI - 7 |
| 14 | IO126NDB7V0 | RX2- | CAT 5E - PRI - 8 |
| 30 | GFA2/IO117PDB6V1 | TX3+ | CAT 5E - SEC -3 |
| 31 | IO117NDB6V1 | TX3- | CAT 5E - SEC -6 |
| 37 | IO112PDB6V1 | TX4+ | CAT 5E - SEC - 7 |
| 38 | IO112NDB6V1 | TX4- | CAT 5E - SEC - 8 |
| 42 | IO106PDB6VO | RX3+ | CAT 5E - SEC -1 |
| 43 | GEC1/IO104PDB6V0 | RX4+ | CAT 5E - SEC -5 |
| 44 | GEC0/IO104NDB6VO | RX4- | CAT 5E - SEC - 4 |
| 45 |  |  | RX3- |

Notes:

1. Pin names are valid only for the A3PE600-PQ208 part. They are not correct for use with an A3P250.
2. J40 - RJ45 connector is referred as CAT 5E PRIMARY connector.
3. J41-RJ45 connector is referred as CAT 5E SECONDARY connector

Refer to the PCB layout, Figure 2-1 on page 10, for the location of J40 and J41 connectors on the PA3 Evaluation board.

## 3 - Setup and Self Test

This chapter outlines how to set up and test the ProASIC3/E Evaluation Board.

## Software Installation

The ProASIC3/E Starter Kit includes the Libero® Integrated Design Environment (IDE) software (version 2.3 SP2). For Libero IDE software installation instructions, refer to the Actel Libero IDE / Designer Installation and Licensing Guide: http://www.actel.com/documents/install_ug.pdf

## Hardware Installation

FlashPro3 is required to use the ProASIC3/E Starter Kit. For software and hardware installation instructions, refer to the FlashPro User's Guide: http://www.actel.com/documents/flashpro_ug.pdf

## Testing the Evaluation Board

Refer to "Test Procedures for Board Testing" on page 69.

## Programming the Test File

To retest the evaluation board at any time, use the test program to reprogram the board. Use the TOP_A3PE.stp file with an A3PE600-PQ208 fitted on the board. Use TOP_A3P.stp with an A3P250PQ208 fitted on the board.

This design is currently implemented for the A3PE600 die size. For a device of a different size, it is possible to recompile the design into other device sizes. For information about retargeting the device, refer to the Designer User's Guide at http://www.actel.com/documents/designer_ug.pdf. The design files are available under actelprj/eval in the Starter Kit CD.
For instructions on programming the device using FlashPro3, refer to the FlashPro User's Guide.

## 4 - Description of Test Design

This description of the test design is provided with the Starter Kit. This design contains a data generator block for LEDs, clock divider, and an LCD display block. A block diagram of the design is shown in Figure 4-1.


## Figure 4-1 • Design Block Diagram

The clock divider divides the 40 MHz oscillator clock and sends the divided clock to the LCD module and the counter. The data generator (Data_Block) generates an eight-bit up-down counter and eight-bit flashing signal. The data generator output is displayed on the ProASIC3E demo board LEDs. You can switch between the data using the SW6 signal. The counter has a synchronous load and an asynchronous clear.

A block diagram of the Data_Block is shown in Figure 4-2.


## Figure 4-2 • Data Block Diagram

A message is generated and displayed on the demo board LCD display. A state machine controls the LDC module.

Table 4-1 • Switches

| Action | Results |
| :--- | :--- |
| Press SW1 | Asynchronous clear for the whole design |
| Press SW2 | Up-Down Control for the 8-bit counter. Press and hold SW2 for <br> down count. |
| Press SW3 | Synchronous load for the 8-bit counter. Press SW3 for loading <br> from the Hex switches. |
| Press SW4 | Switching between manual clock(SW5) and 40 Mhz Oscillator <br> Clock. |
| Press SW5 | Manual clock (very useful for simulation) |
| Press SW6 | Select for DATA_BLOCK. It allows switching LED output between <br> the counter and Flashing data. |
| Change Hex Switch setting (U13 <br> and U14) | Changes the loaded data for the eight-bit counter. |

The state diagram is shown in Figure 4-3.


Figure 4-3 • LCD State Diagram

## 5 - LVDS Signal Evaluation

## Introduction

Due to concerns about the Proasic3 Dev-Kit board layout with respect to the LVDS signaling, the Applications Consulting group took initiative to evaluate the LVDS signaling on the board. The performance criteria of the board with respect to LVDS signaling is set to $300 \mathrm{Mb} / \mathrm{s}$ per product marketing.

This document explains the test setup and design. It reports the measurements performed on the board, and at the end, makes recommendations to increase the LVDS signal quality in order to meet the performance criteria.

## Test Setup

## Hardware

The test setup uses a ProASIC3 Dev-Kit containing an A3PE600-PQ208 engineering sample. LVDS loopback is closed using various lengths of CAT-5E cables (1-, 3-, and 6-foot). The measurements are taken using a 1159A-1GHz Agilent differential probe.

## Design

Figure 5-1 shows the block diagram of the transmitter section of the test design programmed inside the Proasic3 FPGA. As shown in Figure 5-1 on page 29, the design contains two similar channels of data. One channel (channel $A$ ) is driven by PLL to achieve high data rates, and the other (channel B) uses an external clock in case slow data rates are needed for test or debugging purposes.


## Figure 5-1 • TX Portion of Test Design

Each channel uses an LFSR to generate a pseudo-random data stream. The data stream is entered in DDR registers to achieve higher data rates from relatively slower clocks (e.g., $300 \mathrm{Mb} / \mathrm{s}$ data rate from 150 MHz clock). The output of the DDR registers is sent out using the LVDS I/O standard. The output data is looped back and received by the FPGA using LVDS receivers.

## Measurement Results

Figure 5-2 shows the LVDS signal across the 100 Ohm termination resistor at $300 \mathrm{Mb} / \mathrm{s}$. Figure 5-2 shows that the eye height across the termination is about 275 mV which is well within the LVDS spec.


Figure 5-2 • LVDS Signal across RX Termination at 300Mb/s

## 6 - Actel VHDL ProASIC3IE Design Flow

This chapter introduces the design flow for VHDL using the Actel Libero IDE software suite. This chapter also briefly describes how to use the software tools and provides information about the sample design. Figure 6-1 shows the VHDL-based design flow.


Figure 6-1 • VHDL-Based Design Flow
The Libero IDE design flow has four main components:

- Design Entry
- Design Implementation
- Programming
- System Verification


## Design Entry

Design entry consists of capturing a schematic representation of the design and performing functional simulations with a test bench.

## Design Capture

For schematic capture, Libero uses ViewDraw ${ }^{\circledR}$ for Actel, which includes a schematic editor. The schematic editor provides a graphical entry method to capture designs. ViewDraw for Actel is the Libero IDE integrated schematic entry vehicle, supporting mixed mode entry in which HDL blocks and schematic symbols can be mixed.
The ViewDraw wir file is automatically created after using the Save + Check command in ViewDraw. This file is used to create the structural HDL netlist.
For more information on using ViewDraw for Actel, refer to the Libero User's Guide.

## Adding ACTgen Macros

Use the ACTgen Macro Builder to instantly create customized macros and then use ViewDraw to add these macros to a schematic. Alternatively, add the ACTgen Macros in the HDL file.

## Creating and Adding Symbols for HDL Files

Schematic users can encapsulate a HDL block into a block symbol.

## To create a symbol:

1. Right-click the block in the Design Hierarchy window of Libero IDE.
2. Click Create Symbol. Libero IDE generates a symbol for the selected HDL block.

The macro is accessible from the components list in ViewDraw for Actel.

## Test Bench Generation

It is necessary to create a test bench and associate it with a project in order to run a simulation. WaveFormer Lite ${ }^{\text {TM }}$ from SynaptiCAD ${ }^{\text {TM }}$ is the Libero IDE integrated test bench generator. WaveFormer Lite fits perfectly into the Libero IDE, automatically extracting signal information from HDL design files, and producing HDL test bench code that can be used with any standard VHDL or Verilog simulator. WaveFormer Lite generates VHDL and Verilog test benches from drawn waveforms.

## Pre-Synthesis Simulation

Functional simulation verifies that the logic of a design is functionally correct. Simulation is performed using the Libero IDE integrated simulator, ModelSim for Actel, which is a custom edition of ModeISim PE that is integrated into the Libero IDE. ModelSim for Actel is an OEM edition of Model Technology Incorporated (MTI) tools. ModelSim for Actel supports VHDL or Verilog, but it can only simulate one language at a time. It only works with Actel libraries and is supported by Actel.

## Synthesis \& Netlist Generation

After entering the design source, synthesize it to generate a netlist. Synthesis transforms the behavioral HDL source into a gate-level netlist and optimizes the design for a target technology.
For more detailed information on the above topics, refer to the Libero User's Guide.

## Design Implementation

During design implementation, Actel Designer places-and-routes the design.

## Place-and-Route

Start Designer from Libero IDE to place-and-route the design.

## Timing Simulation

Perform timing simulation on the design after place-and-route in Designer. Timing simulation requires information extracted and back-annotated from Designer.

## Optional Tools

The tools listed in Table 6-1 provide optional functions that are not required in a basic design. Use these tools to perform static timing analysis, power analysis, customize I/O placements and attributes, and view the netlist. After place-and-route, perform the post-layout (timing) simulation.

Table 6-1 • Designer User Tools

| Designer User Tools | User Tool Function |
| :--- | :--- |
| Timer | Static timing analysis |
| SmartPower | Power analysis |
| ChipEdit | Customize I/O and logic macro placements |
| PinEdit | Customize I/O placements and attributes |
| Netlist Viewer | View your netlist and trace paths |

For more information on the tools described in the above section, refer to the Designer User's Guide.

## Programming

Program the device with programming software and hardware from Actel or a supported third party programming system. Refer to the Designer User's Guide, Silicon Sculptor User's Guide, and FlashPro User's Guide for information about programming an Actel device. These guides can be found at http://www.actel.com/techdocs/manuals/default.aspx.

## System Verification

Use the Logic Navigator tool to perform system verification on a programmed device.

## 7 - Quick Start Tutorial

This tutorial illustrates a VHDL design for a ProASIC3/E starter kit board. The design is created in Actel Libero IDE v6.2. The steps involved are as follows:
"Step 1 - Create a New Project"
"Step 2 - Perform Pre-Synthesis Simulation"
"Step 3 - Synthesize the Design in Synplify"
"Step 4 - Perform Post-Synthesis Simulation"
"Step 5 - Implement the Design with Designer"
"Step 6 - Perform Timing Simulation with Back-Annotated Timing"
"Step 7 - Generate the Programming File"
"Step 8 - Program the Device"

## Step 1 - Create a New Project

This step uses the Libero IDE HDL Editor to enter an Actel VHDL design.

## To create the VHDL project:

1. Double-click the Libero IDE icon on your desktop to start the program.
2. From the File menu, select New Project. This displays the New Project Wizard, as shown in Figure 7-1.


Figure 7-1 • New Project Wizard in Libero IDE
3. Enter your Project name. For this tutorial, name your project quickstart.
4. Select your HDL type.
5. If necessary, in the Project location field, click Browse to navigate to C:IActelprj. Click Next to continue.

## Microsemi.

6. Select your project Family, Die, and Package. For this tutorial, you can select ProASIC3E, the A3PE600 die, and 208 PQFP for the package (Figure 7-2), or select ProASIC3, the A3P250 die, and 208 PQFP for the package (Figure 7-3).


Figure 7-2•Select A3PE600-PQ208


Figure 7-3•Select A3P250-PQ208
7. Click Next to select Integrated Tools in the New Project Wizard (Figure 7-4).


Figure 7-4 • Selected Integrated Tools in New Project Wizard (Libero IDE)
8. Click the Restore Defaults button to use the default tools included with Libero IDE.
9. Click the Add button to add a different Synthesis, Simulation, or Stimulus tool. If you wish to add a tool, Libero IDE opens the Add Profile dialog box (Figure 7-5).


Figure 7-5 • Add Profile Dialog Box in Libero IDE
10. Name your profile, select a tool from the list of Libero IDE supported tools, and Browse to the Location of your tool. Click OK to return to the New Project Wizard.
11. After you have selected your tools, click Next to continue.

## Microsemi

12. Click Add Files in the New Project Wizard to add existing project design files. Include any ACTgen cores, Block Symbol Files, Schematic Files, VHDL Packages, HDL Source Files, Implementation files, and Stimulus Files (Figure 7-6).


Figure 7-6•Add Files in the New Project Wizard (Libero IDE)
13. Select the file type and click Add Files. Browse to your file, and click Add. Add as many files as you wish in this way. Click Next to continue.
14. Review your project information. Click Finish to close the Wizard and create your new project (Figure 7-7). Click Back to return to any step of the Wizard and correct information in your project.


Figure 7-7 • Summary in New Project Wizard
Your Libero IDE project exists, but you must add code or source to the project, such as a schematic, an ACTgen core, or a VHDL entity or package file, before you can run synthesis.

## To add HDL to your project:

1. From the File menu, click New. This opens the New dialog box, as shown in Figure 7-8.


## Figure 7-8 • New File Dialog Box

2. Select VHDL Entity in the File Type field, enter count 8 in the Name field, and click OK. The HDL Editor opens. Enter the following VHDL file, or if this document is open in an electronic form, copy and paste it from here.
```
library IEEE;
use IEEE.std_logic_1164.all;
use IEEE.std_logic_arith.all;
use IEEE.std_logic_unsigned.all;
entity count8 is
    port(Clock : in std_logic;
        Q : out std_logic_vector(7 downto 0);
        Updown : in std_logic;
        Aclr : in std_logic;
        Sload : in std_logic;
        Data : in std_logic_vector(7 downto 0));
end count8;
architecture behavioral of count8 is
    signal Qaux : UNSIGNED(7 downto 0);
begin
    process(Clock, Aclr)
    begin
        if (Aclr = '1') then
        Qaux <= (others => '0');
        elsif (Sload = '1') then
            Qaux <= UNSIGNED(Data);
        elsif (Clock'event and Clock = '1') then
            if (Updown = '0') then
                    Qaux <= Qaux + 1;
                else
            Qaux <= Qaux - 1;
                end if;
        end if;
    end process;
```


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```
    Q <= std_logic_vector(Qaux);
end behavioral;
```

3. From the File menu, click Save. The design file counter appears in the Design Hierarchy. Libero IDE lists count8.vhd under HDL files in the File Manager, as shown in Figure 7-9.


## Figure 7-9 • Design Hierarchy

4. Check the HDL in the file before you continue. In the Design Hierarchy or File Manager tab (Figure 7-10), right-click count8.vhd and select Check HDL file. This checks the syntax of the count8.vhd file. Before moving to the next section, modify the code if you find any errors.


Figure 7-10 • Design Hierarchy and File Manager Tabs

The rest of the source code is in the /src folder. Right-click Top.vhd in the design hierarchy and select Set As Root so that Top.vhd is represented as the top-level file for the project. You can import all the files from the Libero IDE menu, using File > Import Files (Figure 7-11).


Figure 7-11•Import Source Files

## Step 2 - Perform Pre-Synthesis Simulation

The next step is simulating the RTL description of the design. First, use WaveFormer Lite to create a stimulus for the design and then generate a testbench for the design.

## Create Stimulus Using WaveFormer Lite

WaveFormer Lite generates VHDL testbenches from drawn waveforms. There are three basic steps for creating testbenches using WaveFormer Lite and the Actel Libero IDE software:

1. Import Signal Information
2. Draw Waveforms
3. Export the Testbench

## Import Signal Information

## To launch WaveFormer Lite and import signal information:

Right-click the Top.vhd file in the Design Hierarchy tab and select Create Stimulus > HDL Source files (source files). WaveFormer Lite launches with the port signals in the Diagram window, as shown in Figure 7-12.


Figure 7-12 • WaveFormer Lite Timing Diagram Window

## Draw Waveforms

The state buttons are the buttons with the waveforms drawn on their face: HIGH, LOW, TRIstate, VALid, INValid, WHI weak high, and WLO weak low, as shown in Figure 7-13.


Figure 7-13•State Buttons
When a state button is activated, it is pushed in and colored red. The active state is the type of waveform that is drawn next. Click a state button to activate it.
The state buttons automatically toggle between the two most recently activated states. The state with the small red " $T$ " above the name will be the toggle state. The initial activated state is HIGH and the initial toggle state is LOW.

Signal edges are automatically aligned to the closest edge grid when signals are drawn using the mouse. Control the edge grid from the Options $>$ Grid Settings menu item.

## To draw a waveform:

1. Select the High state and place the mouse cursor inside the Diagram window at the same vertical row as the signal name.
2. Click the mouse button. This draws a waveform from the end of the signal to the mouse cursor. The red state button on the button bar determines the type of waveform drawn. The cursor shape also mirrors the red state button.
3. Move the mouse to the right and click again to draw another segment.

## Copy Waveforms

It is possible to copy and paste sections of waveforms onto (overwrite) or into (insert) any signal in the diagram.

## To copy and paste waveform sections:

1. Select the names of the required signals. If no signals are selected, the Block Copy command selects all the signals in the diagram.
2. Select the Edit > Block Copy Waveforms menu option (choose to select all waveforms, if necessary). This opens the Block Copy Waveforms dialog box (Figure 7-14) with the selected signals displayed in the Change Waveform Destination list box.


Figure 7-14 • Block Copy Waveforms Dialog Box
3. Enter the values that define the copy and paste.
4. Select either Time or Clock cycle for the base units of the dialog.

Remember the following:
When copying only signals (no clocks), time is the default base unit of the dialog.

When copying part of a clock, it is best to choose a clock cycles base unit and choose the copied clock as the reference clock.
If you select time when copying clocks, the end_time minus the start_time must equal an integral number of clock periods, and the place_at time must be at the same clock period offset as the start_time.
Start and End define the times of the block copy.
Place At is the time at which the block will be pasted.
The Insert and Overwrite radio buttons determine whether the paste block is inserted into the existing waveforms or overwrites those waveforms.
The list box at the bottom of the dialog determines which signal the copied waveforms will be pasted into.

## To change this mapping:

1. Select a line in the list box. This places the destination signal in the drop-down list box on top of the list box.
2. Select another signal from the drop-down list box. Each destination signal can be used only once per copy.
3. Click OK to complete the copy and paste operation.

## Export the Testbench

In this step you create a stimulus file for the design and generate a testbench using WaveFormer Lite. After exporting the testbench, perform a pre-synthesis simulation using ModelSim.

## To create a stimulus file and generate a VHDL testbench:

In this step, a design stimulus file is created using WaveFormer Lite. Follow the instructions in the previous sections and define a 20 MHz value for the Clock.

1. Right-click the Clock signal to select it. Select Signal(s) <-> Clock(s) to create the clock signal (Figure 7-15).


Figure 7-15•Create Clock Signal in Waveformer Lite
2. Double-click any clock segment to edit the clock parameters (Figure 7-16). Set a frequency of 40 MHz.


Figure 7-16 • Edit Clock Parameters in WaveFormer Lite
This creates the waveform shown in Figure 7-17.


Figure 7-17•WaveForm Timing Diagram
3. Click the HIGH state button before you start to draw the SW4 waveform. If you have not selected any other state buttons since you drew the clock waveform, you may continue.

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4. Click and drag in the SW4 signal to draw a high segment from 0 to $5 \mu \mathrm{~s}$. When you release the mouse button, WaveFormer Lite switches your state to LOW.
5. Click and drag in the SW4 signal to draw a low segment from 5 us to $6.8 \mu \mathrm{~s}$.
6. Follow similar procedure to enter the rest of the input signals. You will get a waveform similar to the one shown in Figure 7-18.
A waveform was pre-drawn for you and you can find it in the stimulus folder.


Figure 7-18• Testbench Waveform for the Tutorial Design
7. After creating the waveforms, select Save As from the File menu. In the Save As dialog box, enter test_tbench.btim as the file name and click Save.
8. After saving the timing diagram file, select Export Timing Diagram As from the Export menu.
9. Select VHDL wl Top Level Testbench in Files of Type and enter test_tbench.vhd for the file name, as shown in Figure 7-19.


Figure 7-19• Export VHDL Testbench Save As Dialog Box
The WaveFormer Lite Report window displays the VHDL testbench with a component declaration and instantiation inside.
10. Exit WaveFormer Lite (File > Exit). The File Manager displays the stimulus files. The design is ready to simulate under ModelSim.
Alternatively, you can create a testbench using the HDL editor.

## To create a testbench using the HDL editor:

1. From the File menu, select New. This opens the New File dialog box.
2. Select Stimulus HDL file from the File Type list, enter test_tbench for the name, and click OK. The file opens in the HDL Editor.
3. Create the VHDL testbench and save it.

## Pre-Synthesis Simulation

Once you generate a testbench, use ModelSim to perform a pre-synthesis simulation.

## To perform a pre-synthesis simulation:

1. Right-click Top.vhd in the Design Hierarchy tab and choose Organize Stimulus, as shown in Figure 7-20.

| Open HOL file |
| :--- |
| Check HDL flle |
| Create Symbol |
| Organize Designer Constrant Files... |
| Synplify Synthesis |
| Create Stimulus |
| Open Stimulus |
| Organize Stimulus |
| Run Pre-Synthesis Simulation |
| Run Post-Synthesis Simulation |
| Run Post-Layout Simulation |
| Run Designer |
| Run Slicon Scuiptor |
| Run FlashPro |
| Properties |

Figure 7-20• Organize Stimulus Files

## Microsemi

The Organize Stimulus dialog box appears (Figure 7-21).


Figure 7-21 • Organize Stimulus Dialog Box
2. Select test_tbench.vhd in the Stimulus files in the project list box and click Add to add the file to the Associated Files list.
3. Click OK. Stimulus icons in the Design flow window turn green to notify you that there is a testbench file associated with them.
4. Click the Simulation icon in the Design Flow window, or right-click Top in the Design Hierarchy tab and select Run Pre-Synthesis Simulation, as shown in Figure 7-22.

| Open HDL file |
| :--- |
| Check HDL fle |
| Create Symbol |
| Symplify Synthesis |
| Create Sumulus |
| Open Stimulus |
| Organize Stimulus |
| Run Pre-Synthesis Simulation |
| Puin Post-Syntuessi Smuiaton |
| Properties |

Figure 7-22•Run Pre-Synthesis Simulation

The ModeISim VHDL simulator opens and compiles the source files, as shown in Figure 7-23.


Figure 7-23 • ModelSim Main Window
Once the compilation completes, the simulator simulates for the default time period of 1000 ns and a Wave window, shown in Figure 7-24 on page 50, opens to display the simulation results.
5. From the ModelSim menu, select Simulate $>$ Run $>$ Run All to execute the full simulation time defined in the testbench. Scroll in the Wave window to verify that the design functions properly.


Figure 7-24 • ModelSim Wave Window
6. In the ModelSim window, select File $>$ Quit to close the window.

## Step 3 - Synthesize the Design in Synplify

The next step is to generate an EDIF netlist by synthesizing the design in Synplify. For HDL designs, Libero IDE launches and loads Synplicity Synplify synthesizer with the appropriate design files.

## To create an EDIF netlist for the design using Synplify:

1. In the Libero IDE, double-click the Synplify Synthesis icon in the Libero IDE process window, or right-click the Top.vhd file in the Design Hierarchy and select Synthesize. This launches the Synplify synthesis tool with the appropriate design files, as shown in Figure 7-25.


Figure 7-25 • Synplify Main Window
2. From the Project menu, select Implementation Options. This displays the Options for the Implementation dialog box, as shown in Figure 7-26 for A3PE600 and Figure 7-27 for A3P250.


Figure 7-26• Options for Implementation Dialog Box-A3PE600
Set the following in the dialog box:
Technology: Actel ProASIC3E (set by Libero IDE)
Part: A3PE600
Fan-out Guide: 12 (default)
Hard Limit to Fan-out: Off (default). This refers to the fan-out limit.
Accept the default values for each of the other tabs in the Options for Implementation dialog box and click OK.


Figure 7-27• Options for Implementation Dialog Box-A3P250

Set the following in the dialog box:
Technology: Actel ProASIC3 (set by Libero IDE)
Part: A3P250
Fan-out Guide: 12 (default)
Hard Limit to Fan-out: Off (default). This refers to the fan-out limit.
Accept the default values for each of the other tabs in the Options for Implementation dialog box and click OK.
3. In the Synplify main window, click Run. Synplify compiles and synthesizes the design into a netlist called Top.edn. The resulting Top.edn file is then automatically translated by Libero IDE into a VHDL netlist called Top.vhd.
The resulting EDIF and VHDL files are displayed under Implementation Files in the File Manager.
4. If any errors appear after you click the Run button, edit the file using the Synplify editor. To edit the file, double-click the file name in the Synplify window. Any changes made here are saved to the original design file in Libero IDE.
5. Save and close Synplify. From the File menu, click Exit to close Synplify. Click Yes to save any settings made to the Top_syn.prj in Synplify.

## Step 4 - Perform Post-Synthesis Simulation

The next step is simulating the VHDL netlist of the design using the VHDL testbench created in the section, "To create a stimulus file and generate a VHDL testbench:" on page 44.

1. Click the Simulation icon in the Libero IDE Design Flow window, or right-click the Top.vhd file in the Design Hierarchy tab and select Run Post-Synthesis Simulation. This launches the ModelSim Simulator that compiles the source file and testbench.
Once the compilation completes, the simulator runs for 1000 ns and a Wave window opens to display the simulation results.
2. From the ModelSim menu, Simulate $>$ Run $>$ Run All to execute the full simulation time defined in the testbench.
3. Scroll in the Wave window to verify that the counter works correctly. Use the zoom buttons to zoom in and out as necessary.

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## Step 5 - Implement the Design with Designer

After creating and testing the design, the next phase is implementing the Design using the Actel Designer software.

1. Click Designer Place-and-Route in the Libero IDE Design Flow window, or right-click Top.vhd in the Design Hierarchy tab and select Run Designer. Designer (Figure 7-28) reads in the design file and opens the Device Selection Wizard (Figure 7-29 on page 55 for A3PE600 and Figure 7-30 on page 55 for A3P250).


Figure 7-28• Designer GUI


Figure 7-29• Device Selection Wizard-A3PE600

1. Select A3P250 in the Die field and select $\mathbf{2 0 8}$ PQFP in the Package field. Accept the default Speed grade and Die Voltage and click Next.
2. Use the default I/O settings and click Next.
3. Use the default Junction Temperature and Voltage setup and click Finish.


Figure 7-30 • Device Selection Wizard-A3P250
4. Click the Compile icon. Leave the default Compile settings (Figure 7-31) and click OK.


Figure 7-31•Compile Options Window
Designer compiles the design and shows the utilization of the selected device. Also, note that the Compile icon in Designer turns green, indicating that the compile has successfully completed.
5. Once the design compiles successfully, use the I/O Attribute Editor tool to assign the pin for subsequent place-and-route runs. Click the I/O Attribute Editor to open the tool. It opens in the MultiView Navigator user interface, as in Figure 7-32.
6. See the Libero IDE or Designer online help for more information on the I/O Attribute Editor or MultiView Navigator.


Figure 7-32•I/O Attribute Editor in MultiView Navigator
7. Assign a pin number to all of the signals, then select Commit from the File menu and close the I/O Attribute Editor.
8. Another way to assign pin location is to import the Physical Design Constraint (PDC) file as a source file for Compilation. From the Designer menu, select File > Import Source File (Figure 7-33)


Figure 7-33 • Import Designer Source Files
9. Select row 2, then click Add. Browse to the pre-defined Top.pdc file (you can find it in the /src folder). Choose *.pdc for Files of type, click Top.pdc and Import.


Figure 7-34 • Import PDC File
10. Click OK in the Import Source Files window. You need to re-Compile the design once a new PDC file is imported.
(Optional) After successfully compiling the design, use the Designer Tools to view the pre-layout static timing analysis with Timer, set the timing constraints in Timer, analyze the static and dynamic power with SmartPower, and use the ChipPlanner to assign modules. Click the appropriate icon to access these tools.
For more information on these functions, refer to the Designer or Libero online help.
11. In Designer, click Layout. This opens the Layout Options dialog box shown in Figure 7-35.


Figure 7-35 • Layout Options Dialog Box
12. Click OK to accept the default layout options. This runs place-and-route on the design. The Layout icon turns green to indicate that the layout has successfully completed.
13. From Designer, click Back-Annotate in the Design Flow window. This opens the Back-Annotate dialog box, shown in Figure 7-36.


Figure 7-36 • Back-Annotate Dialog Box
14. Accept the default settings and click OK. The Back-Annotate icon turns green.
15. Save and close Designer. From the File menu, click Exit. Click Yes to save the design before closing Designer. Designer saves all the design information in an *.adb file.
The file Top.adb appears under the Designer Files of the File Manager. To reopen the file, rightclick the file and select Open in Designer.

## Step 6 - Perform Timing Simulation with Back-Annotated Timing

After completing the place-and-route and back annotation of the design, perform a timing simulation with the ModelSim HDL simulator.

## To perform a timing simulation:

1. Click the Simulation icon in the Libero IDE Design Flow window, or right-click the Top.vhd file in the Design Hierarchy tab and select Run Post-Layout Simulation.
2. This launches the ModelSim Simulator that compiles the back annotated VHDL netlist file and testbench. Once the compilation completes, the simulator runs for 1000 ns and a Wave window opens to display the simulation results. From the ModelSim menu, select Simulate $>$ Run $>$ Run All to execute the full simulation time defined in the testbench.
3. Scroll in the Wave window to verify that the counter works correctly. Use the zoom buttons to zoom in and out as necessary.

Quick Start Tutorial

## Step 7 - Generate the Programming File

1. Open the Top.adb file in Designer and click the Programming File icon in the Design Flow window, which opens the Flash Point window (Figure 7-37).


Figure 7-37• Flash Point Dialog Box
2. Click Finish, and then the programming file is generated and saved in the Idesignerlimpl1 folder.

## Step 8 - Program the Device

After generating the programming file, program the device using an Actel FlashPro3 programmer.

## Initial Setup

Before performing any action with the FlashPro3 programmer, it must be properly set up. Connect the FlashPro3 USB cable to your PC USB slot, connect the ribbon cable to the programming header on the target board, and turn on the power switch on the board.

## To set up FlashPro3:

1. From the Actel FlashPro software File menu, click Connect. The FlashPro Connect to Programmer dialog box displays, as shown in Figure 7-38.


Figure 7-38•FlashPro3:Connect to Programmer Dialog Box
2. In the Port list, select the USB port. The FlashPro3 programmer is connected as shown in Figure 7-39.


Figure 7-39 • Connect to Programmer Dialog Box for ProASIC3/E Devices
3. In the Configuration list, select ProASIC3/E.
4. Click Connect. A successful connection, or any error, appears in the Log window, as shown in Figure 7-40.


Figure 7-40•FlashPro3 Successful Connection

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## Analyze Chain and Device Selection

## To analyze the chain and select the device:

1. From the File menu, click Analyze Chain. Chain details appear in the Log window, as shown in Figure 7-41.
2. If any failures appear, refer to the error and troubleshooting section of the FlashPro User's Guide. If you have an A3PE600 device on board, you will see the message shown in Figure 7-41.


Figure 7-41•FlashPro3: Analyzing Chain-A3PE600
If you have an A3P250 device on board, you will see the message shown in Figure 7-42.


Figure 7-42•FlashPro3: Analyzing Chain—A3PE250
3. Select the A3PE600 or the A3P250 from the Device list. If only one device is present in the chain, performing Analyze Chain will select that device automatically from the Device list.

## Loading the STAPL File

The FlashPro3 programmer uses a STAPL (*.stp) file to program the device.

## To load the STAPL file:

1. Click the Open File button in the toolbar; or from the File menu, click Open STAPL file. The Open dialog box will appear, as shown in Figure 7-43.


Figure 7-43 • Open STAPL File Dialog Box
2. Browse to your Libero IDE project /designer/impl1 folder, select the STAPL file, and click Open. The FlashPro software loads the file.
You can also find a copy of the Top.stp file in the /src/A3PE600 or /src/A3P250 folder.
The FlashPro Log window will display a message indicating that the software has successfully loaded, as shown in Figure 7-44.


Figure 7-44•STAPL File Load Successfully
Note: If your board has an A3PE600 device, you will see A3PE600 in the Device list.

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## Selecting an Action

After loading the STAPL file, select an action from the Action list. See Table 7-1 for a definition of each action.

Table 7-1 • Action Options

| Option | Action |
| :--- | :--- |
| QUERY_SECURITY | Checks the security status of the device. If the device is <br> programmed with the security key, then this command returns with <br> Read inhibit:1, Write inhibit:1. If the security key is not present, the <br> values are Read inhibit:0, Write inhibit:0. |
| ERASE | Erases the device. |
| READ_IDCODE | Reads the device ID code. |
| VERIFY | Verifies if the device is programmed with the loaded STAPL file. <br> Can be used to ensure that the bitstream programmed in the device <br> is the same as the original STAPL file. If the wrong STAPL file is <br> loaded, Exit 11 appears in the log window. A successful operation <br> results in Exit 0. |
| PROGRAM | Programs the device. |
| DEVICE_INFO | Displays the serial number of the device, the Design Name that is <br> programmed into the device, and the checksum that is programmed <br> into the device. |
| ERASE_FROM | Erases FlashROM only. |
| PROGRAM_FROM | Programs FlashROM only. |
| VERIFY_FROM | Verifies FlashROM only. |
| PROGRAM_ARRAY | Programs the FPGA Array only. |
| ERASE_ARRAY | Erases the FPGA Array only. |
| VERIFY_ARRAY | Verifies the FPGA Array only. |
| PROGRAM | Displays the Device IDCODE, security settings, design name, <br> checksum, and FlashROM content that is programmed into the <br> device. |
| Programs FPGA Array, FlashROM and/or security settings of the |  |
| device. |  |

## Programming the Device

## To program the device:

1. In the Action list, select PROGRAM.
2. In the Device list, select the A3P250 device (or A3PE600 if your board has an A3PE600 device).
3. Click the Execute button in the toolbar.
4. The Execute Action dialog box appears, as shown in Figure 7-45.


Figure 7-45 • Execute Action Dialog Box—Program
All the steps of the programming sequence are listed. Grayed out options are required for programming and cannot be changed. All of these steps, as shown in Figure 7-45, are grayed out because they are required for programming and cannot be changed.
5. Click Execute to start programming. The progress of the programming action displays in the Log window. The message 'Exit 0' indicates that the device has successfully been programmed, as shown in Figure 7-46.
Note: Do not interrupt the programming sequence, it may damage the device or programmer. If you encounter any failures, refer to the troubleshooting section of the FlashPro User's Guide.


Figure 7-46•Successfully Programmed Device
Note: If you have an A3PE600 device on board, you will see A3PE600 in the Device list.

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## Verifying the Correct Programming

## To verify the device is programmed with the correct STAPL file:

1. Load the STAPL file.
2. In the Action list, click Verify.
3. Click the Execute button in the toolbar. The Execute Action dialog box will appear, as shown in Figure 7-47.


Figure 7-47•Execute Action Dialog Box--Verify
The default settings appear in the Execute Action dialog box.
4. Click Execute to start the verification process. A successful verification will result in Exit 0, as shown in Figure 7-48. If the STAPL file is different from the file used for programming, Exit 11 will appear in the Log window.
Note: Do not interrupt the verifying sequence, it may damage the device.


Figure 7-48• Successful Verification
Note: If you have an A3PE600 device on board, you will see A3PE600 in the Device list.

## Saving Your Log File

All FlashPro3 results are displayed in the Log window. Save these results into a file.

## To save the log file:

1. From the File menu, click Save Log. The Save dialog box will appear, as shown in Figure 7-49.


Figure 7-49 • Save Log File Dialog Box
2. Select a directory, type in the file name, and click Save. The FlashPro software saves the file.

## Check Functionality of Tutorial Design

After programming the device, you will see "ACTEL A3PE STARTER KIT" display on the LCD panel as well as flashing LEDs. There are 6 switches (SW) equipped with special functions.
Press SW1 to Asyn_Clear on the flashing LEDs and the LCD panel.
Press SW6 to change the LEDs from flashing to counting.
Press SW3 to Asyn_Load the counter.
Press SW2 to change the up counter to down counter.
Press SW4 for LEDs manual clock.
Press SW5 for LCD manual clock.

## 8 - Test Procedures for Board Testing

## Overview

This document defines the test procedure required to be carried out by the Actel designated manufacturer's testing facility on the ProASIC3/E Evaluation Board with silkscreen labeling A3PE-A3P-EVAL-BRD-1. This testing is specific to the socketed version of the board. All steps in the following enumerated test procedure should be followed in sequence for testing the board. Deviations in the sequence are explained in the text.

## Equipment Required

## Actel Equipment Provided by Actel to Testing Facility

Actel will provide the following:

- This test procedure document.
- FlashPro v3.4 software on a CD-ROM.
- FlashPro3 programmer and programming cable for connecting to the A3PE-A3P-EVAL-BRD1.
- Pre-programmed A3PE600-PQ208 or A3P250-PQ208 silicon. Ten devices will be provided for ten boards. The initial silicon will not be labeled as having been programmed. (This is just for the testing associated with the first manufacturing build.) Additional devices will be provided for testing further boards and this change will be detailed in an update to the procedure.
- Power supply (+9 V, 2 A CUI) for the ProASIC3 Starter Kit board plus a mains cable for the power supply.


## Testing Facility Equipment to be Available for Testing

The manufacturer's testing facility will provide the following equipment for testing of the board:

- Digital Multimeter to measure voltages on the circuit board at the known test points.


## Test Procedure for the A3PE-A3P-EVAL-BRD1

In this section, full test procedure for the boards is outlined. This procedure applies to socketed boards. For boards fitted with directly soldered parts, the procedure is the same except for fitting of the FPGA. In such cases, the reader should adjust the procedure accordingly and ignore references to fitting parts to sockets.

## Initial Power-On Procedure

This part of the procedure may be carried out independently and ahead of the other parts of the test procedure. Boards passing this procedure may be transferred to a passing set of boards.

## To perform the initial power-on procedure:

1. Record the time of the test and the board serial number (written by the bar code on the back of the board) into a test log.
2. Plug the $+9 \vee$ power supply into the wall.
3. Take an A3PE-A3P-EVAL-BRD1 that has an empty socket. Make sure the switch SW11 is in the OFF position, (the switch should be moved to the left). This corresponds with the labeling of the silkscreen on the board.
4. Connect +9 V DC output of the CUI power supply to the $J 18$ connector on the board. You should observe the red LED at the top right of the board, i.e. LED D19 should light indicating +9 V DC has been applied to the board.
5. Move the SW11 switch to the ON position, i.e., move the switch to the right. Observe that LEDs, D13, D9, D10, D11, and D17 light up green on the board. All LEDs are on the top edge of the board (same edge as red D19 power connector LED, which should remain lit).
6. Using a DVM, measure DC voltages using TP11 as ground:

TP6 and TP7 - should be 3.3 V (values $\pm 0.2 \mathrm{~V}$ are acceptable). Values outside this range are a failure.
TP15 - should be 1.5 V (values $\pm 0.1 \mathrm{~V}$ are acceptable).
TP8 - should be 1.8 V (values $\pm 0.1 \mathrm{~V}$ are acceptable).
TP10 - should be 2.5 V (values $\pm 0.2 \mathrm{~V}$ are acceptable).
TP47 - should be 5.0 V (values $\pm 0.2 \mathrm{~V}$ are acceptable).
J14C pin 106 - should be 3.3 V (values $\pm 0.2 \mathrm{~V}$ are acceptable). Note that jumper JP48 must be in place for this measurement, otherwise zero will be recorded.
7. That completes the initial power-on check. The board should now be switched off by moving SW11 to the OFF position (to the left).

## Testing Board Functionality with A3PE600-PQ208 or A3P250-PQ208 Silicon

## To test board functionality:

1. Record the time of the test and the board serial number (written by the bar code on the back of the board) into a test log.
2. Make sure the switch SW11 is in the OFF position (i.e., to the left.)
3. Apply power to the board by attaching the +9 V DC supply to J18. Only the red LED should be illuminated.
4. Undo the four screws holding the socket of $U 8$ in place. Remove the lid of the socket.
5. Place a pre-programmed A3PE600-PQ208 or A3P250-PQ208 FPGA part into the socket using the appropriate vacuum pen while observing anti-static precautions. Make sure that pin 1 of the FPGA is oriented correctly. (The Actel logo on the part should match the orientation of the Actel logo on the board just above the A3PE-A3P-BRD1 part number.) Take great care to make sure all pins are in correct alignment so that the FPGA is on a level plane parallel to the board.
6. Carefully replace the socket cover and screw down all four corners to appropriate tightness. It is recommended to do opposite corners first so as to lessen rotational torque on the part.
7. Switch on SW11 to the ON position (slide it to the right).
8. Validate that all 5 LEDs at the top of the board including the red one turn on. D17, D11, D10, D9, D13, and D19.
9. Validate that the 8 LEDS: D8, D7, ..., and D2, D1 all pulsate in either a counting pattern or a "center to outside swinging" pattern.
10. If no LEDs are visible, stop and switch off SW11. Rotate SW8 and SW9 clockwise to the 3.3 V selection. This is best described with the thicker arrow bar pointing upward. Switch the board back on. The LEDs should be visible. If very dim, stop, switch off the board and rotate the switches one quarter turn clockwise before switching board back on. Continue if the LEDs are glowing. If unable to get a display on the LEDs, the board must be tagged as bad.
11. If it is a bad board, carefully remove the A3PE600-PQ208 or A3P250-PQ208 silicon from the socket and set it aside in an electrostatic-safe area. Using another piece of pre-programmed silicon, repeat steps 4 to 8 above.
If still no response, mark the board as defective and re-use the silicon for other testing. If there is a good response, then place the previous silicon in a "bad" tray to prevent it from being retested.
12. Validate that the patterns can be switched by pressing SW6 (Global pulse) on the left side of board. When the switch is pressed, the LED D15 should momentarily light. The pattern on the 8 LEDs D8 through D1 will change.
13. Validate that the message "Actel A3PE Starter Kit" continually cycles on the LCD display. You may need to turn R40 clockwise to adjust contrast on the display until the message is dark enough to see.
If no message is observed, press buttons SW4 and SW3 simultaneously. This will usually reset the system after a few cycles of the counter.
14. Connect a FlashPro3 programmer to a PC USB port and observe the power light illuminating. Ensure that the FlashPro v3.3 software is installed on the PC being used.
15. Connect the programming cable of the FlashPro3 programmer to the J1 shrouded and keyed header labeled FP3. The red line labeling pin 1 should be close to pin 1 on the header - no other orientation is possible.
16. On the PC, run the FlashPro v3.3 software and connect to the programmer. Select ProASIC3E as the device family. Once the software has shown a connection, select Analyze Chain from the File menu.
If an error message of incorrect VJTAG is reported, then remove the jumper placed at J5 and place it instead at J12 across pins 11 and 12. It may safely be left there. Repeat the Analyze Chain command.
If a message appears indicating that an A3PE600 or A3P250 part (depending on the device fitted to the board) has been detected, then the board has passed this test. Leave the silicon in place in the socket and move to the next step.
If a message of 11 or some other numeric indication appears, then record the message in a test log and fail the board. Remove the silicon from the socket and place it in the safe silicon holding area.
17. This concludes the testing of the board. Switch SW11 to the OFF position and remove the power connector from J18.

## A - PQ208 Package Connections for A3PE600 and A3P250 Devices

Due to the comprehensive and flexible nature of ProASIC3 device user I/Os, a naming scheme is used to show the details of the I/O. The name identifies to which I/O bank it belongs, as well as the pairing and pin polarity for differential I/Os.

I/O Nomenclature = Gmn/IOuxwBy
Gmn is only used for I/Os that also have CCC access - i.e., global pins.
G = Global
$\mathrm{m}=$ Global pin location associated with each CCC on the device: A (northwest corner), B (northeast corner), C (east middle), D (southeast corner), E (southwest corner), and F (west middle)
$\mathrm{n}=$ Global input MUX and pin number of the associated Global location m, either A0, A1,A2, B0, B1, $\mathrm{B} 2, \mathrm{C} 0, \mathrm{C} 1$, or C 2
u = I/O pair number in the bank, starting at 00 from the northwest I/O bank in a clockwise direction
$x=P$ (Positive) or N (Negative) for differential pairs, or S (Single-Ended) for the I/O that support single-ended and voltage-referenced I/O standards only
w = D (Differential Pair) or P (Pair) or S (Single-Ended). D (Differential Pair) if both members of the pair are bonded out to adjacent pins or are separated only by one GND or NC pin; P (Pair) if both members of the pair are bonded out but do not meet the adjacency requirement; or S (SingleEnded) if the I/O pair is not bonded out. For Differential (D) pairs, adjacency for ball grid packages means only vertical or horizontal. Diagonal adjacency does not meet the requirements for a true differential pair.

B = Bank
y = Bank number [0..3] for ProASIC3 and [0..7] for ProASIC3E. Bank number starting at 0 from the northwest I/O bank in a clockwise direction

Figure A-1 on page 74 and Table A-1 are extracted from the ProASIC3 and ProASIC3E datasheets and provide package connections for the A3P250 and A3E600 devices. Pinouts for other devices in the PQ208 family may be found on the Actel website:

ProASIC3 Flash Family FPGAs datasheet at www.actel.com/documents/PA3_DS.pdf
ProASIC3E Flash Family FPGAs datasheet at www.actel.com/documents/PA3E_DS.pdf
These datasheets are included on the ProASIC3 and ProASIC3E Starter Kit CD. However, the website should always be referenced for access to the most recent datasheet.

PQ208 Package Connections for A3PE600 and A3P250 Devices

## 208-Pin PQFP



Figure A-1 • 208-Pin PQFP

Table A-1 • Device Connections for 208-Pin PQFP

| 208-Pin PQFP |  |  |
| :---: | :---: | :---: |
| Pin Number | A3PE600 Function | A3P250 Function |
| 1 | GND | GND |
| 2 | GNDQ | GAA2/IO118PDB3 |
| 3 | VMV7 | IO118NDB3 |
| 4 | GAB2/IO133PSB7V1 | GAB2/IO117PDB3 |
| 5 | GAA2/IO134PDB7V1 | IO117NDB3 |
| 6 | IO134NDB7V1 | GAC2/IO116PDB3 |
| 7 | GAC2/IO132PDB7V1 | IO116NDB3 |
| 8 | IO132NDB7V1 | IO115PDB3 |
| 9 | IO130PDB7V1 | IO115NDB3 |
| 10 | IO130NDB7V1 | IO114PDB3 |
| 11 | IO127PDB7V1 | IO114NDB3 |
| 12 | IO127NDB7V1 | IO113PDB3 |
| 13 | IO126PDB7V0 | IO113NDB3 |
| 14 | IO126NDB7V0 | IO112PDB3 |
| 15 | IO124PSB7V0 | IO112NDB3 |
| 16 | VCC | VCC |
| 17 | GND | GND |
| 18 | VCCIB7 | VCCIB3 |
| 19 | IO122PPB7V0 | IO111PDB3 |
| 20 | IO121PSB7V0 | IO111NDB3 |
| 21 | IO122NPB7V0 | GFC1/IO110PDB3 |
| 22 | GFC1/IO120PSB7V0 | GFC0/IO110NDB3 |
| 23 | GFB1/IO119PDB7V0 | GFB1/IO109PDB3 |
| 24 | GFB0/IO119NDB7V0 | GFB0/IO109NDB3 |
| 25 | VCOMPLF | VCOMPLF |
| 26 | GFA0/IO118NPB6V1 | GFA0/IO108NPB3 |
| 27 | VCCPLF | VCCPLF |
| 28 | GFA1/IO118PPB6V1 | GFA1/IO108PPB3 |
| 29 | GND | GND |
| 30 | GFA2/IO117PDB6V1 | GFA2/IO107PDB3 |
| 31 | IO117NDB6V1 | IO107NDB3 |
| 32 | GFB2/IO116PPB6V1 | GFB2/IO106PDB3 |
| 33 | GFC2/IO115PPB6V1 | IO106NDB3 |
| 34 | IO116NPB6V1 | GFC2/IO105PDB3 |
| 35 | IO115NPB6V1 | IO105NDB3 |

PQ208 Package Connections for A3PE600 and A3P250 Devices

Table A-1 • Device Connections for 208-Pin PQFP (continued)

| 208-Pin PQFP |  |  |
| :---: | :---: | :---: |
| Pin Number | A3PE600 Function | A3P250 Function |
| 36 | VCC | NC |
| 37 | IO112PDB6V1 | IO104PDB3 |
| 38 | IO112NDB6V1 | IO104NDB3 |
| 39 | IO108PSB6V0 | IO103PSB3 |
| 40 | VCCIB6 | VCCIB3 |
| 41 | GND | GND |
| 42 | IO106PDB6V0 | IO101PDB3 |
| 43 | IO106NDB6V0 | IO101NDB3 |
| 44 | GEC1/IO104PDB6V0 | GEC1/IO100PDB3 |
| 45 | GEC0/IO104NDB6V0 | GEC0/IO100NDB3 |
| 46 | GEB1/IO103PPB6V0 | GEB1/IO99PDB3 |
| 47 | GEA1/IO102PPB6V0 | GEB0/IO99NDB3 |
| 48 | GEB0/IO103NPB6V0 | GEA1/IO98PDB3 |
| 49 | GEA0/IO102NPB6V0 | GEA0/IO98NDB3 |
| 50 | VMV6 | VMV3 |
| 51 | GNDQ | GNDQ |
| 52 | GND | GND |
| 53 | VMV5 | NC |
| 54 | GNDQ | NC |
| 55 | IO101NDB5V2 | GEA2/IO97RSB2 |
| 56 | GEA2/IO101PDB5V2 | GEB2/IO96RSB2 |
| 57 | IO100NDB5V2 | GEC2/IO95RSB2 |
| 58 | GEB2/IO100PDB5V2 | IO94RSB2 |
| 59 | IO99NDB5V2 | IO93RSB2 |
| 60 | GEC2/IO99PDB5V2 | IO92RSB2 |
| 61 | IO98PSB5V2 | IO91RSB2 |
| 62 | $\mathrm{V}_{\mathrm{CCI}} \mathrm{B5}$ | $\mathrm{V}_{\mathrm{CCI}} \mathrm{B}^{2}$ |
| 63 | IO96PSB5V2 | IO90RSB2 |
| 64 | IO94NDB5V1 | IO89RSB2 |
| 65 | GND | GND |
| 66 | IO94PDB5V1 | IO88RSB2 |
| 67 | IO92NDB5V1 | IO87RSB2 |
| 68 | IO92PDB5V1 | IO86RSB2 |
| 69 | IO88NDB5V0 | IO85RSB2 |
| 70 | IO88PDB5V0 | IO84RSB2 |

Table A-1 • Device Connections for 208-Pin PQFP (continued)

| 208-Pin PQFP |  |  |
| :---: | :---: | :---: |
| Pin Number | A3PE600 Function | A3P250 Function |
| 71 | VCC | VCC |
| 72 | VCCIB5 | VCCIB2 |
| 73 | IO85NPB5V0 | IO83RSB2 |
| 74 | IO84NPB5V0 | IO82RSB2 |
| 75 | IO85PPB5V0 | IO81RSB2 |
| 76 | IO84PPB5V0 | IO80RSB2 |
| 77 | IO83NPB5V0 | IO79RSB2 |
| 78 | IO82NPB5V0 | IO78RSB2 |
| 79 | IO83PPB5V0 | IO77RSB2 |
| 80 | IO82PPB5V0 | IO76RSB2 |
| 81 | GND | GND |
| 82 | IO80NDB4V1 | IO75RSB2 |
| 83 | IO80PDB4V1 | IO74RSB2 |
| 84 | IO79NPB4V1 | IO73RSB2 |
| 85 | IO78NPB4V1 | IO72RSB2 |
| 86 | IO79PPB4V1 | IO71RSB2 |
| 87 | IO78PPB4V1 | IO70RSB2 |
| 88 | VCC | VCC |
| 89 | VCCIB4 | VCCIB2 |
| 90 | IO76NDB4V1 | IO69RSB2 |
| 91 | IO76PDB4V1 | IO68RSB2 |
| 92 | IO72NDB4V0 | IO67RSB2 |
| 93 | IO72PDB4V0 | IO66RSB2 |
| 94 | IO70NDB4V0 | IO65RSB2 |
| 95 | GDC2/IO70PDB4V0 | IO64RSB2 |
| 96 | IO68NDB4V0 | GDC2/IO63RSB2 |
| 97 | GND | GND |
| 98 | GDA2/IO68PDB4V0 | GDB2/IO62RSB2 |
| 99 | GDB2/IO69PSB4V0 | GDA2/IO61RSB2 |
| 100 | GNDQ | GNDQ |
| 101 | TCK | TCK |
| 102 | TDI | TDI |
| 103 | TMS | TMS |
| 104 | VMV4 | VMV2 |
| 105 | GND | GND |

PQ208 Package Connections for A3PE600 and A3P250 Devices

Table A-1 • Device Connections for 208-Pin PQFP (continued)

| 208-Pin PQFP |  |  |
| :---: | :---: | :---: |
| Pin Number | A3PE600 Function | A3P250 Function |
| 106 | VPUMP | VPUMP |
| 107 | GNDQ | NC |
| 108 | TDO | TDO |
| 109 | TRST | TRST |
| 110 | GJTAG | VJJTAG |
| 111 | GDA0/IO67NPB3V1 | GDB0/IO66NPB3V1 |

Table A-1• Device Connections for 208-Pin PQFP (continued)

| 208-Pin PQFP |  |  |
| :---: | :---: | :---: |
| Pin Number | A3PE600 Function | A3P250 Function |
| 141 | GND | GND |
| 142 | VCC | VCC |
| 143 | IO47NDB2V1 | IO46RSB1 |
| 144 | IO47PDB2V1 | IO45NDB1 |
| 145 | IO44NDB2V1 | IO45PDB1 |
| 146 | IO44PDB2V1 | IO44NDB1 |
| 147 | IO43NDB2V0 | IO44PDB1 |
| 148 | IO43PDB2V0 | IO43NDB1 |
| 149 | IO40NDB2V0 | GBC2/IO43PDB1 |
| 150 | IO40PDB2V0 | IO42NDB1 |
| 151 | GBC2/IO38PSB2V0 | GBB2/IO42PDB1 |
| 152 | GBA2/IO36PSB2V0 | IO41NDB1 |
| 153 | GBB2/IO37PSB2V0 | GBA2/IO41PDB1 |
| 154 | VMV2 | VMV1 |
| 155 | GNDQ | GNDQ |
| 156 | GND | GND |
| 157 | VMV1 | NC |
| 158 | GNDQ | GBA1/IO40RSB0 |
| 159 | GBA1/IO35PDB1V1 | GBA0/IO39RSB0 |
| 160 | GBA0/IO35NDB1V1 | GBB1/IO38RSB0 |
| 161 | GBB1/IO34PDB1V1 | GBB0/IO37RSB0 |
| 162 | GND | GND |
| 163 | GBB0/IO34NDB1V1 | GBC1/IO36RSB0 |
| 164 | GBC1/IO33PDB1V1 | GBC0/IO35RSB0 |
| 165 | GBC0/IO33NDB1V1 | IO34RSB0 |
| 166 | IO31PDB1V1 | IO33RSB0 |
| 167 | IO31NDB1V1 | IO32RSB0 |
| 168 | IO27PDB1V0 | IO31RSB0 |
| 169 | IO27NDB1V0 | IO30RSB0 |
| 170 | VCCIB1 | VCCIB0 |
| 171 | VCC | VCC |
| 172 | IO23PPB1V0 | IO29RSB0 |
| 173 | IO22PSB1V0 | IO28RSB0 |
| 174 | IO23NPB1V0 | IO27RSB0 |
| 175 | IO21PDB1V0 | IO26RSB0 |

PQ208 Package Connections for A3PE600 and A3P250 Devices

Table A-1 • Device Connections for 208-Pin PQFP (continued)

| 208-Pin PQFP |  |  |
| :---: | :---: | :---: |
| Pin Number | A3PE600 Function | A3P250 Function |
| 176 | IO21NDB1V0 | IO25RSB0 |
| 177 | IO19PPB0V2 | IO24RSB0 |
| 178 | GND | GND |
| 179 | IO18PPB0V2 | IO23RSB0 |
| 180 | IO19NPB0V2 | IO22RSB0 |
| 181 | IO18NPB0V2 | IO21RSB0 |
| 182 | IO17PPB0V2 | IO20RSB0 |
| 183 | IO16PPB0V2 | IO19RSB0 |
| 184 | IO17NPB0V2 | IO18RSB0 |
| 185 | IO16NPB0V2 | IO17RSB0 |
| 186 | VCCIB0 | VCCIB0 |
| 187 | VCC | VCC |
| 188 | IO15PDB0V2 | IO16RSB0 |
| 189 | IO15NDB0V2 | IO15RSB0 |
| 190 | IO13PDB0V2 | IO14RSB0 |
| 191 | IO13NDB0V2 | IO13RSB0 |
| 192 | IO11PSB0V1 | IO12RSB0 |
| 193 | IO09PDB0V1 | IO11RSB0 |
| 194 | IO09NDB0V1 | IO10RSB0 |
| 195 | GND | GND |
| 196 | IO07PDB0V1 | IO09RSB0 |
| 197 | IO07NDB0V1 | IO08RSB0 |
| 198 | IO05PDB0V0 | IO07RSB0 |
| 199 | IO05NDB0V0 | IO06RSB0 |
| 200 | VCCIB0 | VCCIB0 |
| 201 | GAC1/IO02PDB0V0 | GAC1/IO05RSB0 |
| 202 | GACO/IO02NDB0V0 | GAC0/IO04RSB0 |
| 203 | GAB1/IO01PDB0V0 | GAB1/IO03RSB0 |
| 204 | GAB0/IO01NDB0V0 | GAB0/IO02RSB0 |
| 205 | GAA1/IO00PDB0V0 | GAA1/IO01RSB0 |
| 206 | GAA0/IOOONDBOV0 | GAA0/IO00RSB0 |
| 207 | GNDQ | GNDQ |
| 208 | VMVO | VMVO |

## B - Board Schematics

This appendix provides illustrations of the ProASIC3/E Evaluation Board.
Note: The following figures are in low resolution. If you would like to see the figures in high resolution, refer to the ProASIC3 Starter Kit Board Schematics, available at www.actel.com/products/hardware/devkits_boards/proasic3_starter.aspx\#docs.

## Top-Level View

Figure B-1 on page 82 illustrates a top-level view of the ProASIC3/E Evaluation Board. Figure B-2 on page 83 illustrates a bottom-level view of the ProASIC3/E Evaluation Board.

## ProASIC3 Schematics

The last pages of this appendix show the following illustrations of the ProASIC3/E Starter Kit Board in order.

Figure B-3 • Main 3.3 V, 2.5 V and 1.5 V Power
Figure B-4 • ProASIC3 FPGA
Figure B-5 • LED and LCD Module Interface Circuit
Figure B-6 • Push-Button and Hex Switches
Figure B-7•FPGA Headers and Expansion Bus
Figure B-8 • Clocks Oscillators and Reset
Figure B-9 • JTAG and JTAG DaisyChain Connector
Figure B-10 • Decoupling Caps, Test Points
Figure B-11•LVDS Signal Routing Via CAT-5E Connectors


Figure B-1 • Top-Level View of ProASIC3/E Evaluation Board


Figure B-2 • Bottom-Level View of ProASIC3/E Evaluation Board


Figure B-3 • Main 3.3 V, 2.5 V and 1.5 V Power


Figure B-4 • ProASIC3 FPGA


Figure B-5•LED and LCD Module Interface Circuit


Figure B-6•Push-Button and Hex Switches


Figure B-7•FPGA Headers and Expansion Bus


Figure B-8•Clocks Oscillators and Reset


Figure B-9 • JTAG and JTAG DaisyChain Connector


Figure B-10 • Decoupling Caps, Test Points


Figure B-11•LVDS Signal Routing Via CAT-5E Connectors

## C - Signal Layers

This is a six-layer board. The board has the following layers of copper:
Layer 1 - Top signal layer
Layer 2 - Ground plane
Layer 3 - Signal layer 3, used for LVDS receive and other signals
Layer 4 - Signal layer 4, used for LVDS transmit and other signals
Layer 5 - Power plane
Layer 6 - Bottom signal layer
Refer to Figure C-1 on page 94 through Figure C-7 on page 100.


Figure C-1 • Layer 1 - Top Signal Layer

Figure C-2 • Layer 2 - Ground Plane (Blank)


Figure C-3 • Layer 3 - Signal 3 (LVDS Receive Layer)


Figure C-4 • Layer 4 - (LVDS Transmit Layer)

Signal Layers

Figure C-5 • Layer 5 - Power Plane (Blank)


Figure C-6•Layer 6 - Bottom


Figure C-7 • Layer 6 - Bottom (Viewed from Bottom)

## D - Product Support

Microsemi SoC Products Group backs its products with various support services, including Customer Service, Customer Technical Support Center, a website, electronic mail, and worldwide sales offices. This appendix contains information about contacting Microsemi SoC Products Group and using these support services.

## Customer Service

Contact Customer Service for non-technical product support, such as product pricing, product upgrades, update information, order status, and authorization.

From North America, call 800.262.1060
From the rest of the world, call 650.318.4460
Fax, from anywhere in the world, 408.643.6913

## Customer Technical Support Center

Microsemi SoC Products Group staffs its Customer Technical Support Center with highly skilled engineers who can help answer your hardware, software, and design questions about Microsemi SoC Products. The Customer Technical Support Center spends a great deal of time creating application notes, answers to common design cycle questions, documentation of known issues, and various FAQs. So, before you contact us, please visit our online resources. It is very likely we have already answered your questions.

## Technical Support

Visit the Customer Support website (www.microsemi.com/soc/support/search/default.aspx) for more information and support. Many answers available on the searchable web resource include diagrams, illustrations, and links to other resources on the website.

## Website

You can browse a variety of technical and non-technical information on the SoC home page, at www.microsemi.com/soc.

## Contacting the Customer Technical Support Center

Highly skilled engineers staff the Technical Support Center. The Technical Support Center can be contacted by email or through the Microsemi SoC Products Group website.


#### Abstract

Email You can communicate your technical questions to our email address and receive answers back by email, fax, or phone. Also, if you have design problems, you can email your design files to receive assistance. We constantly monitor the email account throughout the day. When sending your request to us, please be sure to include your full name, company name, and your contact information for efficient processing of your request. The technical support email address is soc_tech@microsemi.com.


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Customers needing assistance outside the US time zones can either contact technical support via email (soc_tech@microsemi.com) or contact a local sales office. Sales office listings can be found at www.microsemi.com/soc/company/contact/default.aspx.

## ITAR Technical Support

For technical support on RH and RT FPGAs that are regulated by International Traffic in Arms Regulations (ITAR), contact us via soc_tech_itar@microsemi.com. Alternatively, within My Cases, select Yes in the ITAR drop-down list. For a complete list of ITAR-regulated Microsemi FPGAs, visit the ITAR web page.

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Microsemi Corporate Headquarters One Enterprise, Aliso Viejo CA 92656 USA Within the USA: +1 (949) 380-6100
Sales: +1 (949) 380-6136
Fax: +1 (949) 215-4996


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